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## **ON Semiconductor**®

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#### Description

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900 V, 6.3 A, 1.9 Ω

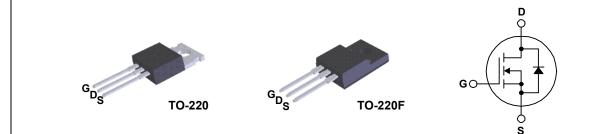
produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 35 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 12 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

FQP8N90C / FQPF8N90C

**N-Channel QFET® MOSFET** 

#### Features

- This N-Channel enhancement mode power MOSFET is 6.3 A, 900 V, R<sub>DS(on)</sub> = 1.9 Ω (Max.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3.15 A



### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQP8N90C	FQPF8N90C	Unit		
V <sub>DSS</sub>	Drain-Source Voltage	9	V			
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		6.3	6.3 *	А	
	- Continuous (T <sub>C</sub> = 100°C)		3.8	3.8 *	А	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	25	25 *	А	
V <sub>GSS</sub>	Gate-Source Voltage	± 30		V		
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	850		mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	6.3		А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	17.1		mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0		V/ns	
P <sub>D</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )		171	60	W	
	- Derate above 25°C		1.37	0.48	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds300				°C	

\* Drain current limited by maximum junction temperature.

#### **Thermal Characteristics**

Symbol	Parameter	FQP8N90C	FQPF8N90C	Unit °C/W	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.73	2.08		
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

Publication Order Number: FQP8N90C / FQPF8N60C/D

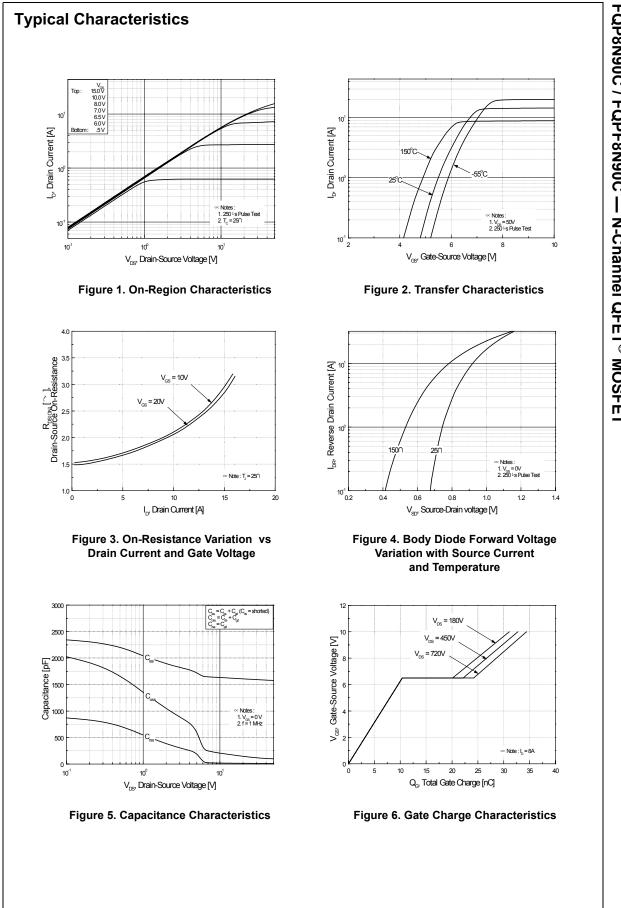
**ON Semiconductor®** 

Part Number FQP8N90C FQPF8N90C		Top Mark	Pack	age	Packing Method Re		Size	Tape Width N/A N/A		Quantity 50 units 50 units	
		FQP8N90C	TO-2	220	Tube	N/A N/A					
		FQPF8N90C	TO-2	20F	Tube						
ectric	cal Cha	racteristics	T <sub>C</sub> = 25°C	unless othe	erwise noted.						
Symbol	ymbol Parameter			Test Conditions			Min.	Тур.	Max.	Unit	
Off Cha	racterist	ics									
BV <sub>DSS</sub>		rce Breakdown Volta	age	$V_{GS} = 0$	) V, I <sub>D</sub> = 250 μA		900			V	
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, Referenced to 25°C				0.95		V/°C		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V					10	μA		
			V <sub>DS</sub> = 720 V, T <sub>C</sub> = 125°C					100	μA		
I <sub>GSSF</sub>	Gate-Bod	y Leakage Current, I	orward	V <sub>GS</sub> = 3	80 V, V <sub>DS</sub> = 0 V				100	nA	
I <sub>GSSR</sub>	Gate-Bod	y Leakage Current, I	Reverse	$V_{GS}$ = -30 V, $V_{DS}$ = 0 V			-		-100	nA	
On Cha	racterist	ics									
V <sub>GS(th)</sub>		shold Voltage		$V_{DS} = V$	/ <sub>GS</sub> , I <sub>D</sub> = 250 μA		3.0		5.0	V	
R <sub>DS(on)</sub>	Static Drai On-Resist	in-Source		_	0 V, I <sub>D</sub> = 3.15 A			1.6	1.9	Ω	
9 <sub>FS</sub>	Forward T	ransconductance		$V_{DS} = 5$	io V, I <sub>D</sub> = 3.15 A			5.5		S	
-	1	cteristics									
C <sub>iss</sub>	Input Capacitance Output Capacitance		$V_{\rm DS}$ = 25 V, $V_{\rm GS}$ = 0 V,			1600	2080	pF			
C <sub>oss</sub>				f = 1.0 MHz				130	170	pF	
C <sub>rss</sub>	Reverse I	Reverse Transfer Capacitance						12	15	pF	
Switchi	ng Chara	acteristics									
t <sub>d(on)</sub>	Turn-On D	elay Time		$V_{} = 0$	50 V = 8 A			40	90	ns	
t <sub>r</sub>	Turn-On F	Rise Time		$V_{DD}$ = 450 V, I <sub>D</sub> = 8 A, R <sub>G</sub> = 25 Ω			-	110	230	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time						70	150	ns	
t <sub>f</sub>	Turn-Off F	all Time				(Note 4)		70	150	ns	
Qg	Total Gate	Charge		V <sub>DS</sub> = 7	20 V, I <sub>D</sub> = 8 A,		-	35	45	nC	
Q <sub>gs</sub>	Gate-Sou	rce Charge		V <sub>GS</sub> = 1			-	10	-	nC	
Q <sub>gd</sub>	Gate-Drai	n Charge				(Note 4)		14		nC	
	ł		etice an	d Max	imum Patings			1		-1	
I <sub>S</sub>	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current						6.3	А			
I <sub>SM</sub>			e Diode Forward Current					25	Α		
V <sub>SD</sub>		rce Diode Forward			) V, I <sub>S</sub> = 6.3 A				1.4	V	
t <sub>rr</sub>		Recovery Time	<u> </u>		) V, I <sub>S</sub> = 8 A,			530		ns	
Q <sub>rr</sub>		Recovery Charge		00	= 100 A/µs			5.8		μC	

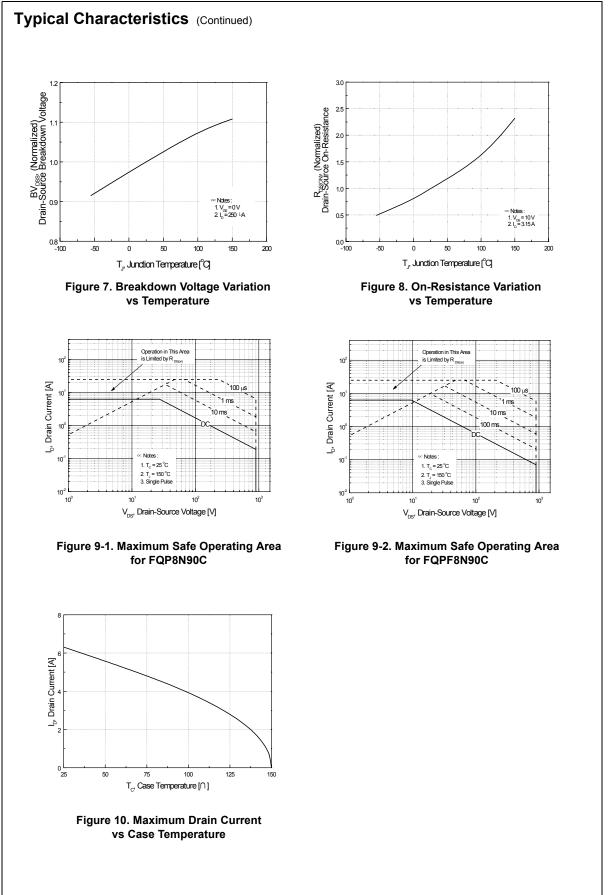
FQP8N90C / FQPF8N90C — N-Channel QFET<sup>®</sup> MOSFET

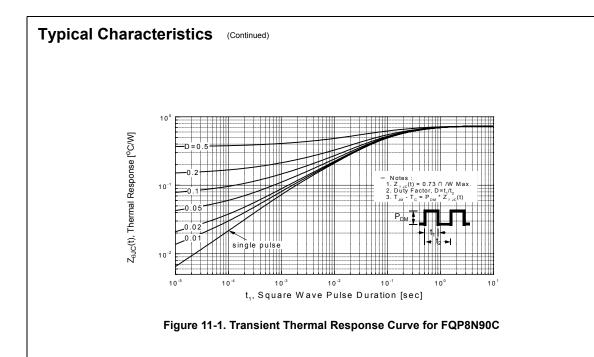
Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 40 mH, I<sub>AS</sub> = 6.3 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub> ≤ 8 A, di/dt ≤ 200 A/µs , V<sub>DD</sub> ≤ BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C. 4. Essentially independent of operating temperature.

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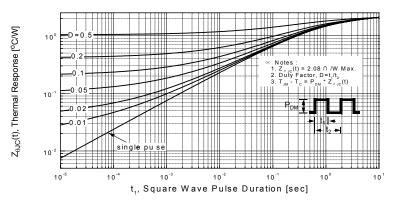
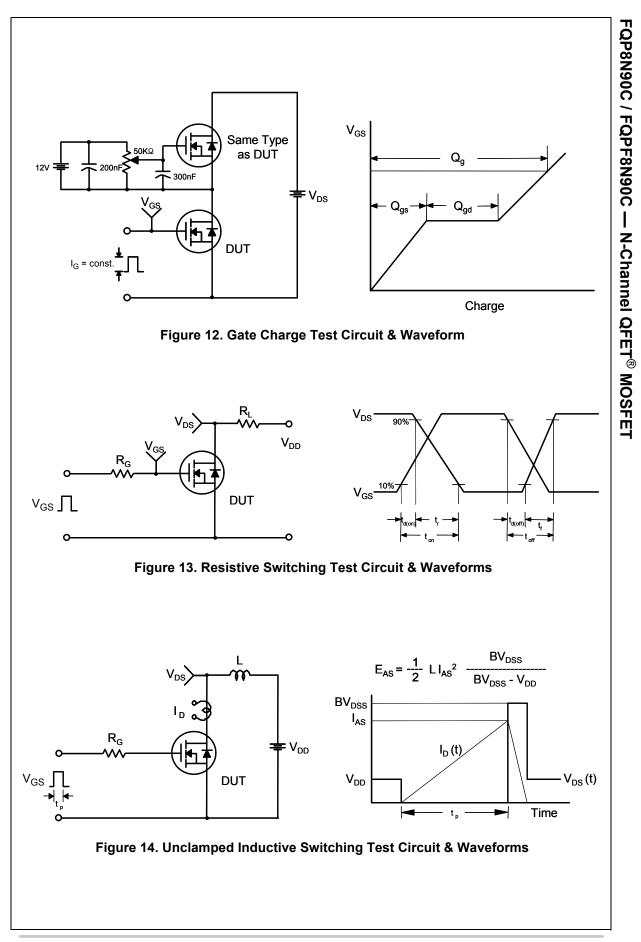
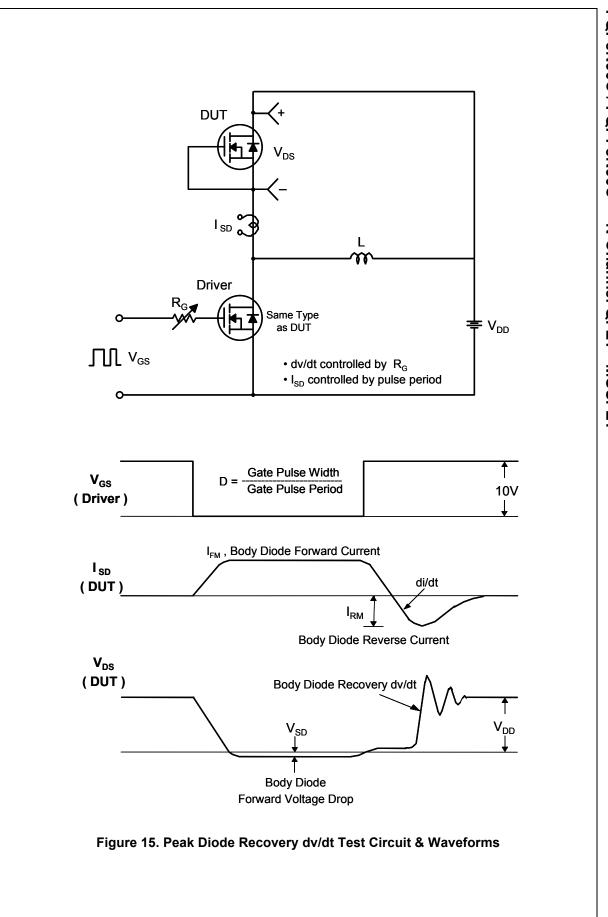


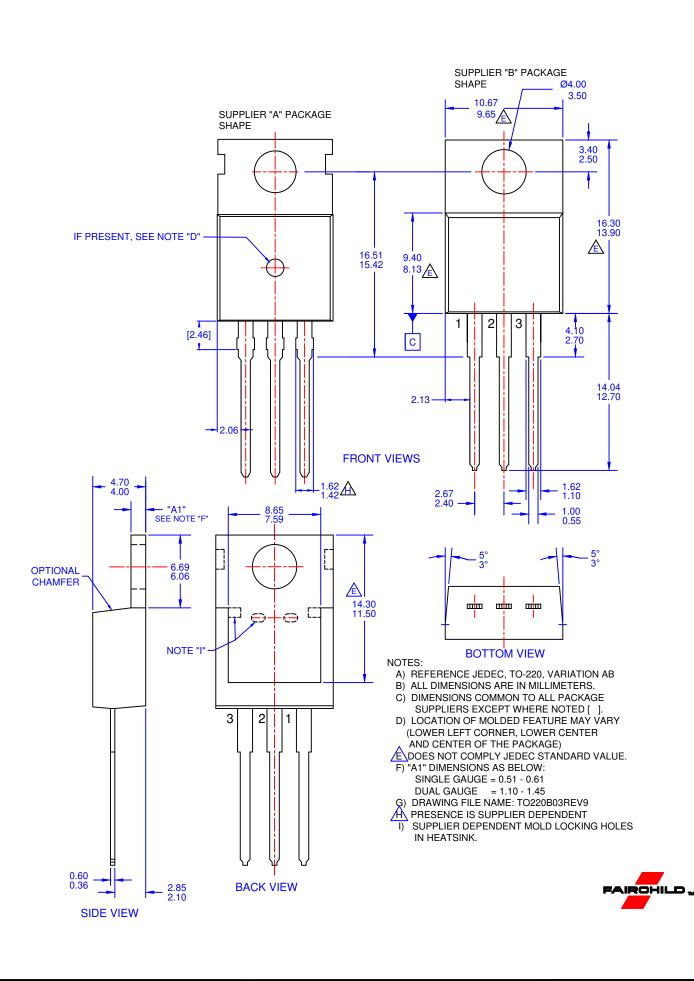
Figure 11-2. Transient Thermal Response Curve for FQPF8N90C

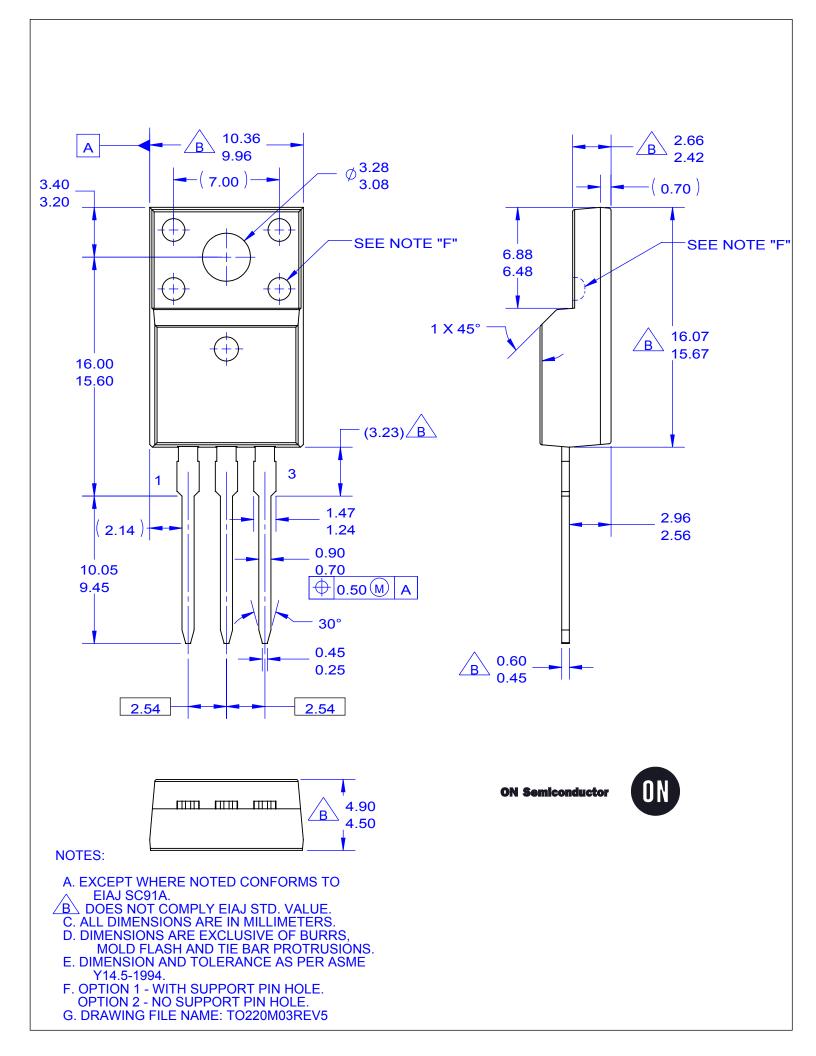


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